

MLA Varistor Series



Size Table

Metric	EIA
1005	0402
1608	0603
2012	0805
3216	1206
3225	1210

Absolute Maximum Ratings

• For ratings of individual members of a series, see device ratings and specifications table.

-	• •	
Continuous	ML Series	Units
Steady State Applied Voltage		
DC Voltage Range ($V_{M(DC)}$)	3.5 to 120	V
AC Voltage Range ($V_{M(AC)RMS}$)	2.5 to 107	V
Transient		
Non-Repetitive Surge Current, 8/20µs Waveform, (I_{TM})	4 to 500	А
Non-Repetitive Surge Energy, 10/1000 μs Waveform, (W $_{TM})$	0.02 to 2.5	J
Operating Ambient Temperature Range (T_A)	-55 to +125	°C
Storage Temperature Range (T _{STG})	-55 to +150	°C
Temperature Coefficient (αV) of Clamping Voltage (V_c) at Specified Test Current	<0.01	%/° C

Additional Information



Description

The MLA Series family of transient voltage surge suppression devices is based on the Littelfuse Multilayer fabrication technology. These components are designed to suppress a variety of transient events, including those specified in IEC 61000-4-2 or other standards used for Electromagnetic Compliance (EMC). The MLA Series is typically applied to protect integrated circuits and other components at the circuit board level.

The wide operating voltage and energy range make the MLA Series suitable for numerous applications on power supply, control and signal lines.

The MLA Series is manufactured from semiconducting ceramics, and is supplied in a leadless, surface mount package. The MLA Series is compatible with modern reflow and wave soldering procedures.

It can operate over a wider temperature range than Zener diodes, and has a much smaller footprint than plastichoused components.

Littelfuse Inc. manufactures other multilayer series products. See the MLE Series data sheet for ESD applications, MHS Series data sheet for high-speed ESD applications, the MLN Series for multiline protection and the AUML Series for automotive applications.

Features

- Halogen-Free and RoHS compliant
- Leadless 0402, 0603, 0805, 1206 and 1210 chip sizes
- Multilayer ceramic construction technology
- -55°C to +125°C operating temp. range
 Operating voltage
- Operating voltage range V_{M(DC)} = 3.5V to 120v

- Rated for surge current (8 x 20µs)
- Rated for energy (10 x 1000µs)
- Inherent bi-directional clamping
- Standard low capacitance types available

Applications

- Suppression of inductive switching or other transient events such as EFT and surge voltage at the circuit board level
- ESD protection for IEC 61000-4-2, MIL-STD-883 method 3015.7, and other industry specifications (see also the MLE or MLN Series)
- Provides on-board transient voltage protection for ICS and transistors
- Used to help achieve electromagnetic compliance of end products
- Replace larger surface mount TVS Zeners in many applications



Device Ratings and Specifications

			Specifications (25°C)						
Part Number	Maximum Continuous Working Voltage		Maximum Non- repetitive Surge Current (8/20µs) Energy(10/1000µ:		Maximum Clamping Voltage(8/20µs)	Nominal Voltage Test Current@ 1mA DC		Typical Capacitance@ 1MHz	
	VM (DC)	VM (AC)	I _{TM}	WTM	VC @ 1A	VN (DC)	VN (DC)	С	
	(V)	(V)	(A)	(L)	(V)	Min (V)	Max (V)	(pF)	
V3.5MLA0603N⁵	3.5	2.5	30	0.100	13.0	3.7	7.0	1270	
V3.5MLA0805N	3.5	2.5	60	0.300	13.0	3.7	7.0	1760	
V3.5MLA0805LN	3.5	2.5	40	0.100	13.0	3.7	7.0	1380	
V3.5MLA1206N	3.5	2.5	100	0.300	13.0	3.7	7.0	5800	
V5.5MLA0402N8	5.5	4.0	20	0.050	21.0	7.1	10.8	220	
V5.5MLA0402LN ⁸	5.5	4.0	20	0.05	39	15.9	21.5	70	
V5.5MLA0603N⁵	5.5	4.0	30	0.100	17.5	7.1	9.3	960	
V5.5MLA0603LN4	5.5	4.0	30	0.100	17.5	7.1	9.3	450	
V5.5MLA0805N	5.5	4.0	120	0.300	17.5	7.1	9.3	1200	
V5.5MLA0805LN	5.5	4.0	40	0.100	17.5	7.1	9.3	660	
V5.5MLA1206N	5.5	4.0	150	0.400	17.5	7.1	9.3	2800	
V9MLA0402N8	9.0	6.5	20	0.050	30.0	11.0	16.0	120	
V9MLA0402LN ⁸	9.0	6.5	4	0.020	35.0	11.0	16.0	33	
V9MLA0603N ⁵⁸	9.0	6.5	30	0.100	25.5	11.0	16.0	490	
V9MLA0603LN48	9.0	6.5	30	0.100	25.5	11.0	16.0	360	
V9MLA0805LN ⁸	9.0	6.5	40	0.100	25.5	11.0	16.0	320	
V12MLA0805LN ⁸	12.0	9.0	40	0.100	29.0	14.0	18.5	220	
V14MLA0402N ⁸	14.0	10.0	20	0.050	39.0	15.9	21.5	70	
V14MLA0603N ⁸	14.0	10.0	30	0.100	34.5	15.9	21.5	180	
V14MLA0805N8	14.0	10.0	120	0.300	32.0	15.9	20.3	360	
V14MLA0805LN ⁸	14.0	10.0	40	0.100	32.0	15.9	20.3	200	
V14MLA1206N8	14.0	10.0	150	0.400	32.0	15.9	20.3	800	
V18MLA0402N8	18.0	14.0	20	0.050	50.0	22.0	28.0	40	
V18MLA0603N ⁸	18.0	14.0	30	0.100	50.0	22.0	28.0	120	
V18MLA0805N8	18.0	14.0	120	0.300	44.0	22.0	28.0	260	
V18MLA0805LN ⁸	18.0	14.0	40	0.100	44.0	22.0	28.0	170	
V18MLA1206N8	18.0	14.0	150	0.400	44.0	22.0	28.0	1030	
V18MLA1210N8	18.0	14.0	500	2.500	44.0 at 2.5	22.0	28.0	2500	
V18MLA1812N78	18.0	14.0	1000	2.900	44.0 at 5	22.0	28.0	4050	
V26MLA0603N8	26.0	20.0	30	0.100	60.0	31.0	38.0	110	
V26MLA0805N8	26.0	20.0	100	0.300	60.0	29.5	38.5	110	
V26MLA0805LN ⁸	26.0	20.0	40	0.100	60.0	29.5	38.5	90	
V26MLA1206N8	26.0	20.0	150	0.600	60.0	29.5	38.5	630	
V26MLA1210N8	26.0	20.0	300	1.200	60.0 at 2.5	29.5	38.5	1250	
V30MLA0603N8	30.0	25.0	30	0.100	74.0	37.0	46.0	90	
V30MLA0805LN ⁸	30.0	25.0	30	0.100	72.0	37.0	46.0	85	
V30MLA1206N8	30.0	25.0	180	1.000	67.0	35.0	43.0	400	
V30MLA1210N ⁸	30.0	25.0	280	1.200	68.0 at 2.5	35.0	43.0	685	
V30MLA1210LN ⁸	30.0	25.0	220	0.900	68.0 at 2.5	35.0	43.0	500	



Device Ratings and Specifications (Continue...)

			Specifications (25°C)						
Part Number	Maximum Continuous Working Voltage		Maximum Non- repetitive Surge Current (8/20µs)	Maximum Non- repetitive Surge Energy(10/1000µs)	Maximum Clamping Voltage(8/20µs)	Nominal Voltage Test Current@ 1mA DC		Typical Capacitance@ 1MHz	
	VM (DC)	VM (AC)	I _{TM}	WTM	VC @ 1A	VN (DC)	VN (DC)	с	
	(V)	(V)	(A)	(J)	(V)	Min (V)	Max (V)	(pF)	
V30MLA1812N78	30.0	25.0	800	3.700	65.0 at 5	35.0	43.0	1900	
V33MLA1206N8	33.0	26.0	180	0.800	75.0	38.0	49.0	390	
V38MLA1812N7 8	38.0	30.0	800	4.500	77.0 at 5	43.0	52.0	1450	
V42MLA1206N8	42.0	30.0	180	0.800	92.0	46.0	60.0	345	
V45MLA1812N7 8	45.0	35.0	500	4.000	90.0 at 5	50.4	61.6	1200	
V48MLA1206N8	48.0	40.0	180	0.900	100.0	54.5	66.5	185	
V48MLA1210N8	48.0	40.0	250	1.200	105.0 at 2.5	54.5	66.5	400	
V48MLA1210LN ⁸	48.0	40.0	220	0.900	105.0 at 2.5	54.5	66.5	380	
V56MLA1206N8	56.0	40.0	180	1.000	120.0	61.0	77.0	180	
V60MLA1210N8	60.0	50.0	250	1.500	130.0 at 2.5	67.0	83.0	230	
V68MLA1206N8	68.0	50.0	180	1.000	140.0	76.0	90.0	130	
V85MLA1210N8	85.0	67.0	250	2.500	180.0 at 2.5	95.0	115.0	160	
V120MLA1210N8	120.0	107.0	125	2.000	260.0 at 2.5	135.0	165.0	70	

NOTES:

1. 'L' suffix is a low capacitance and energy version; Contact your Littelfuse sales representative for custom capacitance requirements

2. Typical leakage at 25°C<25µA, maximum leakage 100µA at V_{MDC}; for 0402 size, typical leakage <5µA, maximum leakage <20µA at V_{MDC};

3. Average power dissipation of transients for 0402, 0603, 0805, 1206 and 1210 sizes not to exceed 0.03W, 0.05W, 0.1W, 0.1W and 0.15W respectively.

4. Item is available as 'R' packing option only. All 0402 size items available as 'R' packaging option only. See Packaging section for additional information.

5. Item is available in 'H', T'and 'A' packing option only. All 0805, 1206 and 1210 parts come as 'H', T'and 'A' packing option only. See Packaging section for additional information.

6. The typical capacitance rating is the discrete component test result.

7. Item is available in "T" packing option only.

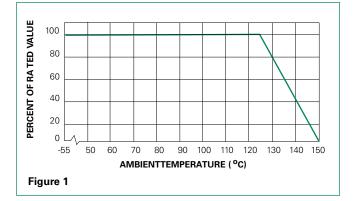
8. ESD rated to IEC61000-4-2 level 4: air discharge 15KV, contact 8KV

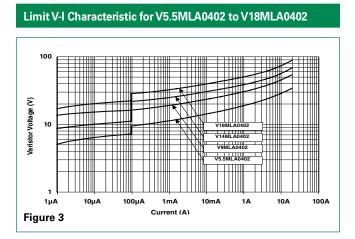
9. ESD higher rating than IEC61000-4-2(level 4), please contact littelfuse



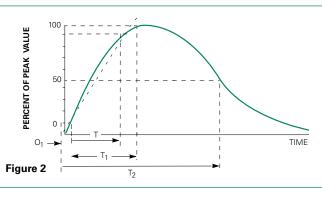
Peak Current and Energy Derating Curve

When transients occur in rapid succession, the average power dissipation is the energy (watt-seconds) per pulse times the number of pulses per second. The power so developed must be within the specifications shown on the Device Ratings and Specifications Table for the specific device. For applications exceeding 125°C ambient temperature, the peak surge current and energy ratings must be derated as shown below.





Peak Pulse Current Test Waveform for Clamping Voltage



$0_1 = Virtual Origin of Wave$

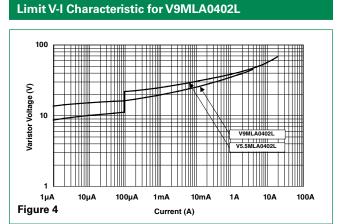
T = Time from 10% to 90% of Peak

 $T_1 = Rise Time = 1.25 \times T$

 $T_2 = Decay Time$

Example - For an 8/20 μ s Current Waveform:

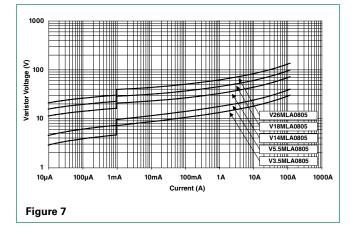
- $8\mu s = T_1 = Rise Time$
- $20\mu s = T_2 = Decay Time$

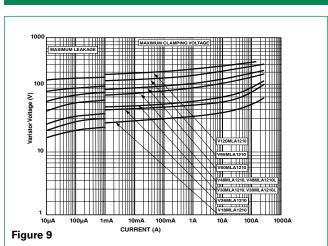




Limit V-I Characteristic for V3.5MLA0603 to V30MLA0603 V30MLA V26ML V18MLA /14ML Varistor Voltage -111 100u/ 1mA 100mA 1A 10A 10µ/ 10mA Current (A) Figure 5

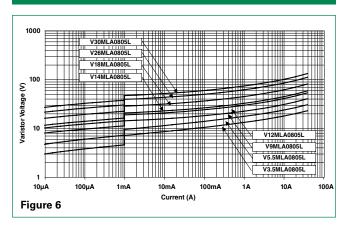
Limit V-I Characteristic for V3.5MLA0805 to V26MLA0805



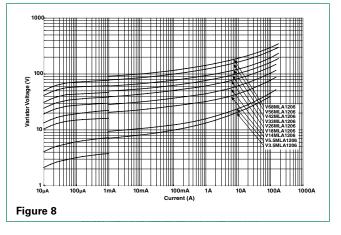


Limit V-I Characteristic for V18MLA1210 to V120MLA1210

Limit V-I Characteristic for V3.5MLA0805L to V30MLA0805L



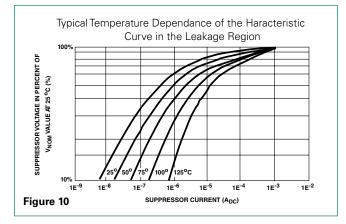
Limit V-I Characteristic for V3.5MLA1206 to V68MLA1206





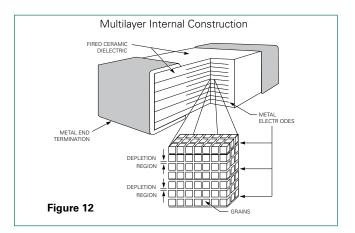
Device Characteristics

At low current levels, the V-I curve of the multilayer transient voltage suppressor approaches a linear (ohmic) relationship and shows a temperature dependent effect. At or below the maximum working voltage, the suppressor is in a high resistance modex (approaching $10^{6}\Omega$ at its maximum rated working voltage). Leakage currents at maximum rated voltage are below 100μ A, typically 25μ A; for 0402 size below 20μ A, typically 5μ A.

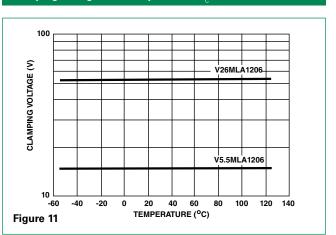


Speed of Response

The Multilayer Suppressor is a leadless device. Its response time is not limited by the parasitic lead inductances found in other surface mount packages. The response time of the Z_NO dielectric material is less than 1ns and the MLA can clamp very fast dV/dT events such as ESD. Additionally, in "real world" applications, the associated circuit wiring is often the greatest factor effecting speed of response. Therefore, transient suppressor placement within a circuit can be considered important in certain instances.



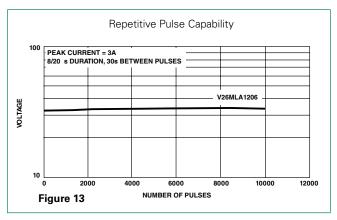
Clamping Voltage Over Temperature (V_c at 10A)



Energy Absorption/Peak Current Capability

Energy dissipated within the MLA Series is calculated by multiplying the clamping voltage, transient current and transient duration. An important advantage of the multilayer is its interdigitated electrode construction within the mass of dielectric material. This results in excellent current distribution and the peak temperature per energy absorbed is very low. The matrix of semiconducting grains combine to absorb and distribute transient energy (heat) (see Speed of Response). This dramatically reduces peak temperature; thermal stresses and enhances device reliability.

As a measure of the device capability in energy and peak current handling, the V26MLA1206A part was tested with multiple pulses at its peak current rating (3A, $8/20\mu$ s). At the end of the test, 10,000 pulses later, the device voltage characteristics are still well within specification.





Lead (Pb) Soldering Recommendations

The principal techniques used for the soldering of components in surface mount technology are IR Re-flow and Wave soldering. Typical profiles are shown on the right.

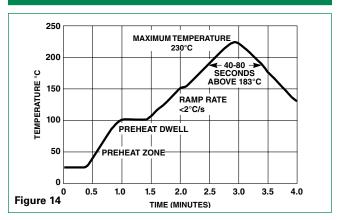
The recommended solder for the MLA suppressor is a 62/36/2 (Sn/Pb/Ag), 60/40 (Sn/Pb) or 63/37 (Sn/Pb). Littelfuse also recommends an RMA solder flux.

Wave soldering is the most strenuous of the processes. To avoid the possibility of generating stresses due to thermal shock, a preheat stage in the soldering process is recommended, and the peak temperature of the solder process should be rigidly controlled.

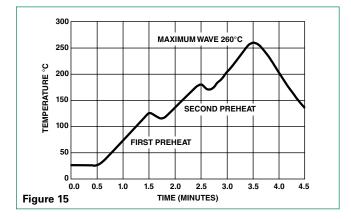
When using a reflow process, care should be taken to ensure that the MLA chip is not subjected to a thermal gradient steeper than 4 degrees per second; the ideal gradient being 2 degrees per second. During the soldering process, preheating to within 100 degrees of the solder's peak temperature is essential to minimize thermal shock.

Once the soldering process has been completed, it is still necessary to ensure that any further thermal shocks are avoided. One possible cause of thermal shock is hot printed circuit boards being removed from the solder process and subjected to cleaning solvents at room temperature. The boards must be allowed to cool gradually to less than 50° C before cleaning.

Reflow Solder Profile



Wave Solder Profile



Lead-free (Pb-free) Soldering Recommendations

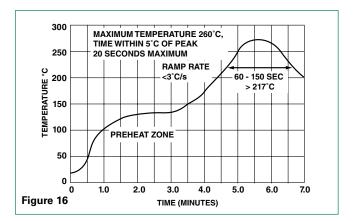
Littelfuse offers the Nickel Barrier Termination option (see "N" suffix in Part Numbering System for ordering) for the optimum Lead–free solder performance, consisting of a Matte Tin outer surface plated on Nickel underlayer, plated on Silver base metal.

The preferred solder is 96.5/3.0/0.5 (SnAgCu) with an RMA flux, but there is a wide selection of pastes and fluxes available with which the Nickel Barrier parts should be compatible.

The reflow profile must be constrained by the maximums in the Lead–free Reflow Profile. For Lead–free wave soldering, the Wave Solder Profile still applies.

Note: the Lead–free paste, flux and profile were used for evaluation purposes by Littelfuse, based upon industry standards and practices. There are multiple choices of all three available, it is advised that the customer explores the optimum combination for their process as processes vary considerably from site to site.

Lead-free Re-flow Solder Profile

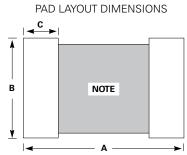




D

CHIP LAYOUT DIMENSIONS

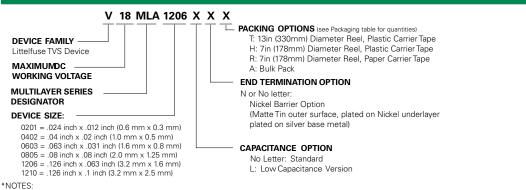
Product Dimensions (mm)



NOTE : Avoid metal runs in this area, parts not recommended for use in applications using Silver (Ag) epoxy paste.

Dimension	1210 Size		1206 Size		0805 Size		0603 Size		0402 Size	
Dimension	IN	ММ	IN	ММ	IN	ММ	IN	ММ	IN	ММ
А	0.160	4.06	0.160	4.06	0.120	3.05	0.100	2.54	0.067	1.70
В	0.100	2.54	0.065	1.65	0.050	1.27	0.030	0.76	0.020	0.51
С	0.040	1.02	0.040	1.02	0.040	1.02	0.035	0.89	0.024	0.61
D (max.)	0.113	2.87	0.071	1.80	0.043	1.10	0.040	1.00	0.024	0.60
E	0.020 -/+0.010	0.50 -/+0.25	0.020 -/+0.010	0.50 -/+0.25	0.020 -/+ 0.010	0.50 -/+ 0.25	0.015 -/+0.008	0.4 -/+0.20	0.010 -/+0.006	0.25 -/+0.15
L	0.125 -/+0.012	3.20 -/+0.30	0.125 -/+0.012	3.20 -/+0.30	0.079 -/+0.008	2.01 -/+0.20	0.063 -/+0.006	1.6 -/+0.15	0.039 -/+0.004	1.00 -/+0.10
w	0.100 -/+0.012	2.54 -/+0.30	0.060 -/+0.011	1.60 -/+0.28	0.049 -/+0.008	1.25 -/+0.20	0.032 -/+0.060	0.8 -/+0.15	0.020 -/+0.004	0.50 -/+0.10

Part Numbering System



1 V120MLA1210 standard shipping quantities are 1000 pieces per reel for the "H" option and 4000 pieces per reel for "T" option. 2 V3.5 MLA0603, V5.5MLA0603 and V9MLA0603 only available in "H," "T" and "A" packing options.

Packaging*

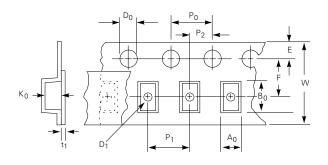
	Quantity							
Device Size	13″ Inch Reel ("T" Option)	7″ Inch Reel ("H" Option)	7″ Inch Reel ("R" Option)	Bulk Pack ("A" Option)				
1812	4,000	N/A	N/A	N/A				
1210	8,000	2,000	N/A	2,000				
1206	10,000	2,500	N/A	2,500				
0805	10,000	2,500	N/A	2,500				
0603	10,000	2,500	4,000	2,500				
0402	N/A	N/A	10,000	N/A				

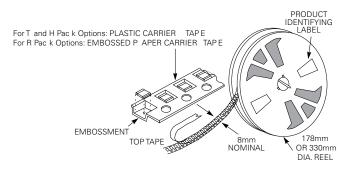
*(Packaging) It is recommended that parts be kept in the sealed bag provided and that parts be used as soon as possible when removed from bags.

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Tape and Reel Specifications





Symbol	Description	Dimensio	Dimensions in Millimeters			
Symbol	Description	0402 Size	0603, 0805, 1206 & 1210 Sizes			
A ₀	Width of Cavity	Dependent on Chip Size to Minimize Rotation.				
B ₀	Length of Cavity	Dependent on Chip Size to Minimize Rotation.				
K ₀	Depth of Cavity	Dependent on Chip	Size to Minimize Rotation.			
w	Width of Tape	8 -/+0.2	8 -/+0.3			
F	Distance Between Drive Hole Centers and Cavity Centers	3.5 -/+0.05	3.5 -/+0.05			
E	Distance Between Drive Hole Centers and Tape Edge	1.75 -/+0.1	1.75 -/+0.1			
P ₁	Distance Between Cavity Centers	2-/+0.05	4 -/+0.1			
P ₂	Axial Drive Distance Between Drive Hole Centers & Cavity Centers	2 -/+0.1	2 -/+0.1			
P _o	Axial Drive Distance Between Drive Hole Centers	4 -/+0.1	4 -/+0.1			
D	Drive Hole Diameter	1.55 -/+0.05	1.55 -/+0.05			
D ₁	Diameter of Cavity Piercing	N/A	1.05 -/+0.05			
Τ,	Top Tape Thickness	0.1 Max	0.1 Max			

NOTES:

Conforms to EIA-481-1, Revision A

• Can be supplied to IEC publication 286-3

Mouser Electronics

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V18MLA0402NR V5.5MLA0402LNR V14MLA0402NR V5.5MLA0402NR V60MLA1210NH V9MLA0402LNR V14MLA0805LWT V30MLA0603A V42MLA1206A V42MLA1206NA V5.5MLA0805NA V68MLA1206NT V12MLA0805LWA V120MLA1210H V33MLA1206NA V18MLA0805WA V3.5MLA0805LT V42MLA1206WH V5.5MLA0603WH V9MLA0805LNT V5.5MLA1206A V85MLA1210NH V14MLA0805H V14MLA1206A V26MLA0805A V3.5MLA0603NA V56MLA1206WA V12MLA0805LH V18MLA0805LNH V26MLA0805LH V3.5MLA0805LWA V30MLA0603NA V33MLA1206A V5.5MLA0805WA V14MLA0805LNA V18MLA1206NA V30MLA0603WH V30MLA0805LT V48MLA1210LWA V9MLA0603WA V30MLA0805LA V48MLA1210LA V5.5MLA0402NH V5.5MLA0805WH V9MLA0603NT V18MLA0805LT V3.5MLA0603WA V30MLA0603NH V68MLA1206T V12MLA0805LA V18MLA0805NA V26MLA0603H V26MLA0805WA V3.5MLA0603WH V42MLA1206NT V5.5MLA0805NH V14MLA0603A V14MLA0805A V26MLA0805LNT V26MLA0805NA V3.5MLA0805LH V9MLA0402NH V14MLA0805NA V18MLA0805NT V26MLA0805LA V18MLA0805NH V9MLA0805LA V18MLA0805A V26MLA1210WA V30MLA0603NT V14MLA0402NH V14MLA1206 V3.5MLA1206NT V42MLA1206WA V5.5MLA0805LNH V9MLA0402LNH V26MLA0805LNA V3.5MLA0805NT V3.5MLA1206H V9MLA0603WH V120MLA1210WA V14MLA0603T V56MLA1206NH V68MLA1206WA V85MLA1210A V33MLA1206WA V14MLA0603H V26MLA0603A V26MLA1206H V5.5MLA0603NT V14MLA0805NH V18MLA0805LA V18MLA0805T V5.5MLA0603WA V5.5MLA1206NT V18MLA0603NT V18MLA1206T V42MLA1206NH V5.5MLA0805LNT V5.5MLA1206H